

N-channel 800 V, 0.29 Ω typ., 14 A MDmesh™ K5 Power MOSFET in a TO-220FP package

Datasheet - production data

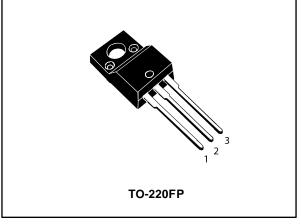
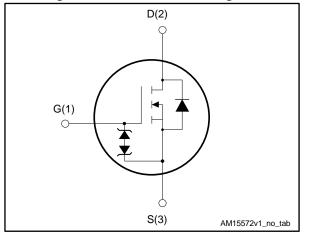


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID
STF17N80K5	800 V	0.34 Ω	14 A

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STF17N80K5	17N80K5	TO-220FP	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 30	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	14	А
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	9	А
I _{DM} ⁽²⁾	Drain current (pulsed)	56	А
P _{TOT}	Total dissipation at $T_C = 25 \text{ °C}$	30	W
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T_C =25 °C)	2500	V
dv/dt ⁽³⁾	Peak diode recovery voltage slope	4.5)//
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	V/ns
TJ	Operating junction temperature range	- 55 to 150	.0°
T _{stg}	Storage temperature range	- 55 10 150	C

Notes:

⁽¹⁾Limited by maximum junction temperature.

 $^{\rm (2)} {\rm Pulse}$ width limited by safe operating area

 $^{(3)}I_{SD} \leq$ 14 A, di/dt 100 A/µs; V_Ds peak < V_{(BR)DSS},V_DD= 400 V

 $^{(4)}V_{DS} \le 640 \text{ V}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	4.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax})$	4.7	А
E _{AS}	Single pulse avalanche energy (starting Tj = 25 °C, I_D = I_{AR}, V_{DD} = 50 V)	340	mJ



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	800			V
	$V_{GS} = 0 V, V_{DS} = 800 V$			1	μA	
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 800 V T _C = 125 °C			50	μA
I _{GSS}	Gate body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±10	μΑ
V _{GS(th)}	Gate threshold voltage	V_{DD} = V_{GS} , I_D = 250 μ A	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	V_{GS} = 10 V, I_{D} = 7 A		0.29	0.34	Ω

Table 5: On/off-state

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	866	-	pF
C _{oss}	Output capacitance	$V_{DS} = 100 \text{ V}, \text{ f} = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	64	-	pF
C _{rss}	Reverse transfer capacitance	163 - 0 1	-	0.42	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 640 V,	-	142	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0 V$	-	51	-	pF
Rg	Intrinsic gate resistance	$f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$	-	5	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, \text{ I}_{D} = 14 \text{ A}$	-	26	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	7.2	-	nC
Q _{gd}	Gate-drain charge	See (Figure 15: "Test circuit for gate charge behavior")	-	15.2	-	nC

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

 $^{(2)}\mathsf{E}\mathsf{nergy}$ related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{\text{DD}}\text{=}\;400$ V, I_{D} =7 A, R_{G} = 4.7 Ω	-	14.8	-	ns
tr	Rise time	V _{GS} = 10 V	-	10.8	-	ns
t _{d(off)}	Turn-off delay time	See (Figure 14: "Test circuit for resistive load switching times" and	-	84.3	-	ns
t _f	Fall time	Figure 19: "Switching time waveform")	-	10.1	-	ns

Table 7: Switching times





Electrical characteristics

	Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
I _{SD}	Source-drain current		-		14	А		
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		56	А		
V _{SD} ⁽²⁾	Forward on voltage	I_{SD} = 14 A, V_{GS} = 0 V	-		1.6	V		
t _{rr}	Reverse recovery time	$I_{SD} = 14 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, \text{V}_{DD}$	-	439		ns		
Q _{rr}	Reverrse recovery charge	= 60 V See Figure 16: "Test circuit for	-	6.37		μC		
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times"	-	29		А		
t _{rr}	Reverse recovery time	$I_{SD} = 14 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s V}_{DD}$	-	626		ns		
Qrr	Reverse recovery charge	= 60 V, T _j = 150 °C See Figure 16: "Test circuit for inductive load switching and diode recovery times"	-	8.36		μC		
I _{RRM}	Reverse recovery current		-	26.7		А		

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

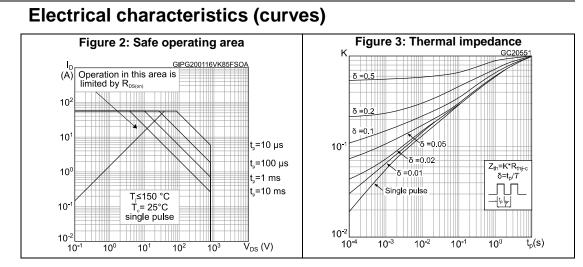
Table 9: Gate-source Zener diode

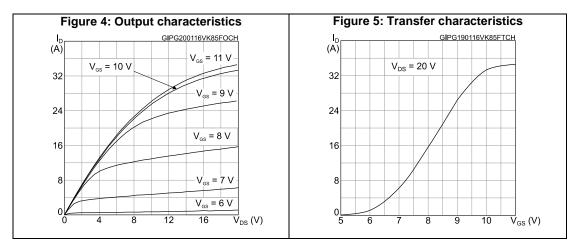
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	I_{GS} = ± 1mA, I_{D} = 0 A	30	-	-	V

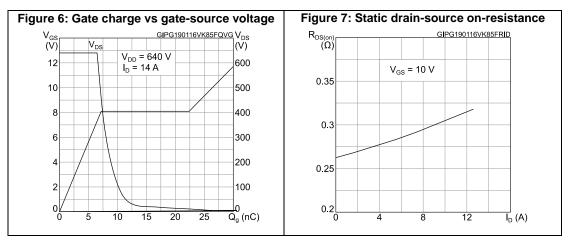
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



2.2



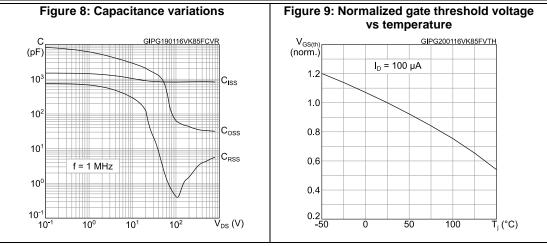


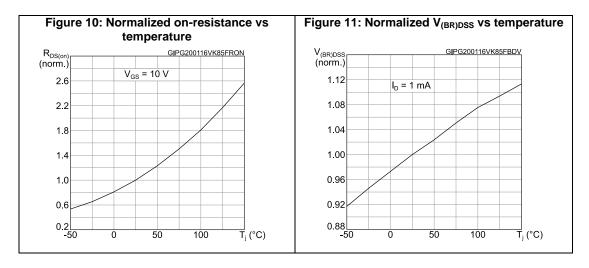


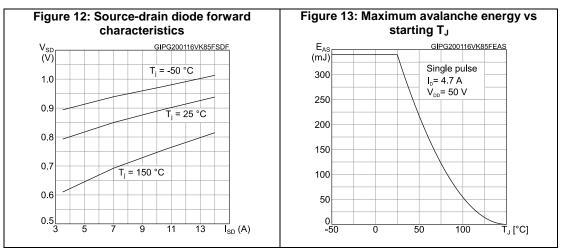
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Electrical characteristics

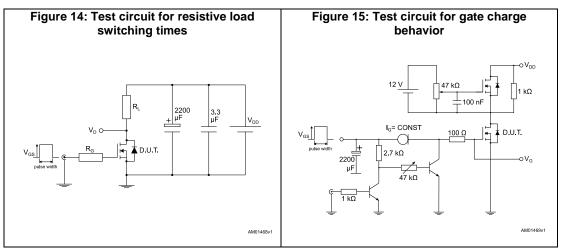


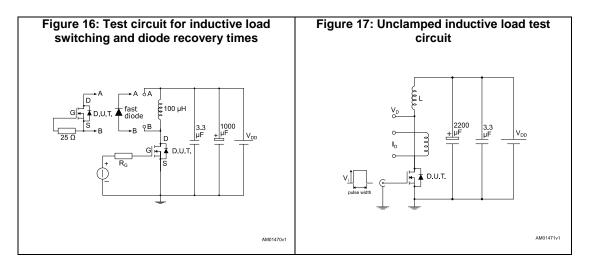


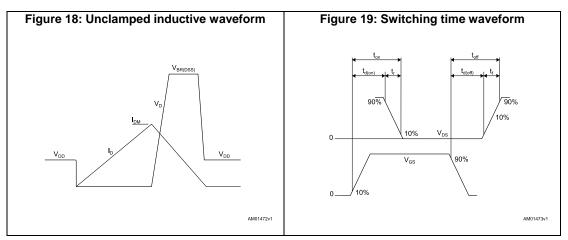


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3 Test circuits







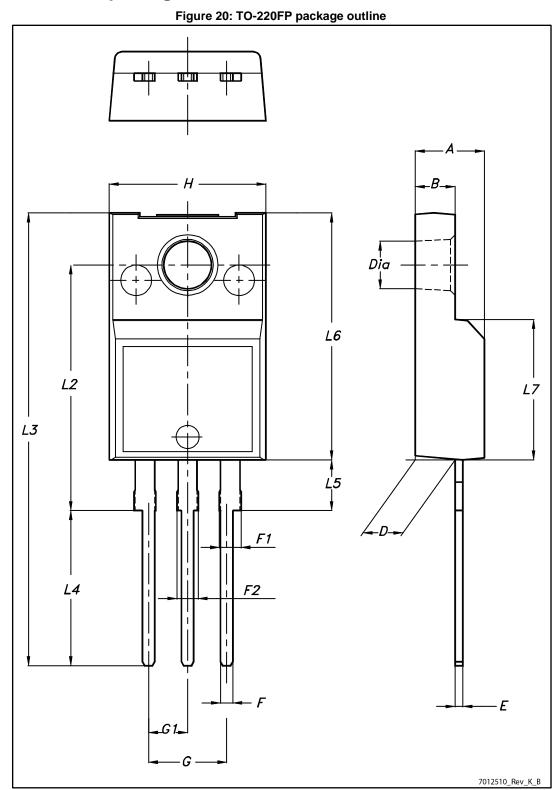


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.









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K5			Package information
	Table 10: TO-220FP pa	ickage mechanical data	
Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



Revision history 5

Date	Revision	Changes
31-Mar-2015	1	First release.
20-Jan-2016	2	Modified: Table 4: "Avalanche characteristics", Table 6: "Dynamic", Table 7: "Switching times", and Table 8: "Source-drain diode" Added: Section 3.1: "Electrical characteristics (curves)" Minor text changes



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